

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT6744548

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
DAI-LIANG MA	04/28/2021
BANG-YING YU	04/28/2021
BO-CHENG LIN	04/28/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TAISIC MATERIALS CORP.
<b>Street Address:</b>	NO.5, TZU-CHIANG 1ST RD., ZHONGLI DIST.,
<b>City:</b>	TAOYUAN CITY
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	320
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17338642
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2069548911
<b>Email:</b>	admin@iptrustononline.com
<b>Correspondent Name:</b>	IP TRUST
<b>Address Line 1:</b>	1321 UPLAND DRIVE
<b>Address Line 2:</b>	PMB 8552
<b>Address Line 4:</b>	HOUSTON, TEXAS 77043
<b>ATTORNEY DOCKET NUMBER:</b>	PTP2112037TW-US
<b>NAME OF SUBMITTER:</b>	ELLEN LAZOR
<b>SIGNATURE:</b>	/Ellen Lazor/
<b>DATE SIGNED:</b>	06/03/2021
<b>Total Attachments: 3</b>	
source=PTP2112037TW-US_APP_LtO_Declaration#page1.tif	
source=PTP2112037TW-US_APP_LtO_Declaration#page2.tif	
source=PTP2112037TW-US_APP_LtO_Declaration#page3.tif	

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR ASSIGNEE**

<b>Title of Invention</b>	<b>HIGH-PURITY SEMI-INSULATING SINGLE-CRYSTAL SILICON CARBIDE WAFER AND CRYSTAL</b>
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<b>Docket Number</b>	
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As the below named inventor, I hereby declare that:

This declaration is directed to:  The attached application, or  
 United States application or PCT international application number \_\_\_\_\_ filed on \_\_\_\_\_.

The above-identified application was made or authorized to be made by me.  
 I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  
 I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

WHEREAS, **TAISIC MATERIALS CORP.** having a principal place of business at **NO.5, TZU-CHIANG 1ST RD., ZHONGLI DIST., TAOYUAN CITY 320, TAIWAN**, desires to secure an equal, undivided right, title and interest in said invention and the patent application filed thereon.

As used hereinafter, the term "ASSIGNEE" refers to the foregoing parties either collectively or individually.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the ASSIGNOR hereby assigns to the ASSIGNEE, the entire right, title and interest in said invention and in the above-identified United States patent application and in all divisions, continuations and continuations-in-part of said application filed in the United States, and reissues, extensions and renewals of Letters Patent granted thereon in the United States, and in all Letters Patents issuing on any such patent applications in the United States.

ASSIGNOR hereby assigns to the ASSIGNEE the right to claim priority in the United States, under the terms of the International Convention and any other relevant treaties, to any prior patent application for said invention filed in a country foreign to the United States or to a prior international patent application for said invention.

ASSIGNOR hereby authorizes and requests the United States Patent & Trademark Office to issue any and all of said Letters Patent to the ASSIGNEE as the assignee of ASSIGNOR'S entire right, title and interest in and to the same, for the sole use and behoof of the ASSIGNEE, its successors, assigns, and legal representatives, to the full end of the term for which said Letters Patent may be granted.

Further, ASSIGNOR agrees, without further consideration, to communicate to the ASSIGNEE any facts known to ASSIGNOR respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part, substitute, renewal and reissue applications, execute all necessary assignment papers to cause said Letters Patent to be issued to the ASSIGNEE, make all rightful oaths, and, perform all lawful acts to aid the ASSIGNEE, its successors and assigns, to obtain and enforce Letters Patent for said invention in the United States.

**LEGAL NAME OF INVENTOR**

Inventor: Dai-Liang MA

Date: 4/28/2007

Signature: Dai-Liang Ma

**IP Trust**  
 1321 Upland Drive PMB 8552,  
 Houston TX 77043, USA

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<b>LEGAL NAME OF INVENTOR</b>		
Inventor:	Bang-Ying YU	Date: 2021. 4. 28
Signature:	<i>Bang-Ying Yu</i>	

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<b>LEGAL NAME OF INVENTOR</b>		
Inventor:	Bo-Cheng LIN	Date: <u>2021, Oct. 28</u>
Signature:	<u>Bo-cheng, Lin</u>	

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